



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Talieh et al. Serial No.: 10/716,116 Filed: November 18, 2003 Title: Method And System To Provide Material Removal And Planarization Employing A Reactive Pad	Group Art Unit: 1765 Examiner: Docket: NT-021D-US
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INFORMATION DISCLOSURE STATEMENT

US PATENT DOCUMENTS

Examiner Initials	Cite No.	Document Number	Publication Date	Name of Patentee or Applicant	
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Examiner Initials	Cite No.	Document Number	Publication Date	Name of Patentee or Applicant		

OTHER DOCUMENTS

Examiner Initials	Cite No.			Translation

Examiner Signature	JL	Date Considered	7/11/05
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